

# **J** +1-858-405-9771 **≅** qil057@ucsd.edu **Q** GitHub Profile

#### **EDUCATION**

### •University of California, San Diego

2024-

<u>Electrical and Computer Engineering</u>, Doctor of Philosophy Advised by Dr. Xinyu Zhang

•School of Electronics Engineering and Computer Science, Peking University

2019-2024

Major: Electronic Information Engineering, Bachelor of Science

CGPA/Percentage: 3.697/Top 3

Advised by Dr. Boya, Di

National School of Development, Peking University

2021-2024

Double Degree: Economics, Bachelor of Economics

#### RESEARCH INTERESTS

#### Wireless Communication and Networks

5G and beyond Internet of Things

# **Mobile Computing**

Edge Computing
Sensing and Localization
Augmented Reality and Virtual Reality

### **Machine Learning**

Deep Learning Reinforcement Learning Transfer and Meta learning

## **PUBLICATIONS**

- 1. Luo, Q., and Di, B. Meta Learning for Meta-Surface: A Fast Beamforming Method for RIS-Assisted Communications Adapting to Dynamic Environments. In <u>IEEE INFOCOM 2023 IEEE Conference on Computer Communications Workshops (INFOCOM WKSHPS) (May 2023)</u>, pp. 1–2
- 2. Luo, Q., Di, B., and Han, Z. Meta-Critic Reinforcement Learning for IOS-Assisted Multi-User Communications in Dynamic Environments. In <u>2023 IEEE 97th Vehicular Technology Conference (VTC2023-Spring)</u> (Jun. 2023), pp. 1–6
- 3. Luo, Q., Yang, Z., Di, B., and Xu, C. Demo: Meta2Locate: Meta Surface Enabled Indoor Localization in Dynamic Environments. In Proceedings of the Twenty-Fourth International Symposium on Theory, Algorithmic Foundations, and Protocol Design for Mobile Networks and Mobile Computing (New York, NY, USA, Oct 2023), MobiHoc '23, Association for Computing Machinery, p. 312–313
- 4. Luo, Q., Han, Z., and Di, B. Meta-critic reinforcement learning for intelligent omnidirectional surface assisted multi-user communications. IEEE Transactions on Wireless Communications 23, 8 (2024), 9085–9098
- 5. Luo, Q., Zhang, H., Xu, M., Di, B., Chen, A., Mao, S., Niyato, D., and Han, Z. An Overview of 3GPP Standardization for Extended Reality (XR) in 5G and Beyond. <u>GetMobile: Mobile Comp. and Comm. 27</u>, 3 (Nov 2023), 10–17

For more details, please visit my homepage and find the publications link.

# EXPERIENCE

•Research Intern

2022-2024

Future Internet of Things Lab, Peking University

Beijing, China

- Advised by Dr. Boya, Di from School of Electronics, Peking University.

### **PRESENTATIONS**

### **In-person Poster Session**

In IEEE Conference on Computer Communications, Hoboken, NJ, USA, May 2023.

#### **Virtual Oral Presentation**

In IEEE 97th Vehicular Technology Conference, Florence, Italy, Jun. 2023.

## **In-person Demo Session**

In 24th International Symposium on Theory, Algorithmic Foundations, and Protocol Design for Mobile Networks and Mobile Computing, Washington DC, USA, Oct. 2023.

# Positions of Responsibility

- •Reviewer, The 98th IEEE Vehicular Technology Conference (VTC2023-Fall)
- •Reviewer, International Conference on Wireless Communications and Signal Processing
- •Reviewer, IEEE Internet of Things Journal
- •Reviewer, IEEE Transactions on Vehicular Technology
- •Reviewer, IEEE International Conference on Machine Learning for Communication and Networking
- •Reviewer, IEEE International Conference on Communications
- •Reviewer, IEEE Transactions on Machine Learning in Communications and Networking

# AWARD & FUNDING

•Innovation Project of Science, sponsored by the government of Beijing	2022-2024
•Undergraduate Research Program, sponsored by Peking University	2022-2024
•Academic Innovation Award, awarded by Peking University	2023
•Outstanding Research Award, awarded by Peking University	2023
•Shenzhen Stock Exchange Fellowship, awarded by Peking University and Shenzhen Stock Exchange	nge <i>2023</i>
•Top 10 Excellent Graduation Thesis, awarded by School of Electronics Engineering and	
Computer Science, Peking University	2024
•Outstanding Undergraduate Graduation Thesis, awarded by Peking University	2024
•Outstanding Graduate in Electronic Information Engineering awarded by School of	
Electronics Engineering and Computer Science, Peking University	2024